

Data sheet

Title: FIXED CHIP RESISTOR NETWORKS; RECTANGULAR
TYPE

Style: RACA10 4D,RACA16 4D

Automotive Grade
AEC-Q200 qualified

RoHS COMPLIANCE ITEM
Halogen and Antimony Free

Note: •Stock conditions

Temperature: +5°C ~ +35°C

Relative humidity: 25% ~ 75%

The period of guarantee: Within 2 year from shipment by the company.

Solderability shall be satisfied.

•Product specification contained in this data sheet are subject to change at
any time without notice

•If you have any questions or a Purchasing Specification for any quality
agreement is necessary, please contact our sales staff.



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1. Scope

1.1 This data sheet covers the detail requirements for fixed chip resistors networks; rectangular type, style of RACA10 4D, RACA16 4D.

1.2 Applicable documents

JIS C 5201-1: 2011, IEC60115-1: 2008, AEC-Q200 Rev.D

2. Classification

Type designation shall be the following form.

(Example) 1.	RACA	10	4	D	103	J	C	TH
	1	2	3	4	5	6	7	8
	Style							
2.	RACA	10	4	D	JP		C	TH
	1	2	3	4	5		7	8
	Style							

- 1 Fixed chip resistors networks; rectangular type
2 Size
3 Number of element
4 Circuits
5 Rated resistance
- } Style

103	E24 Series, 3 digit, Ex. 103--> 10kΩ,
1000	E96 Series, 4 digit, Ex. 1000-->100Ω 1022--> 10.2kΩ
JP	Chip jumper

6 Tolerance on rated resistance

F	±1%
J	±5%

7 Terminal style

C	Convex Type
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8 Packaging form

TH	Paper taping
TP	

3. Rating

The ratings shall be in accordance with Table-1.

3.1 Resistor

Table-1(1)

Style	Terminations style	Rated element dissipation (W)	Temperature coefficient of resistance (10 ⁻⁶ / °C)	Rated resistance range(Ω)	Preferred number series for resistors	Tolerance on rated resistance
RACA10 4D	C	0.063	±200	1~1M	E24, E96	F(±1%)
					E24	J(±5%)
RACA16 4D	C	0.1	±200	1~1M	E24, E96	F(±1%)
					E24	J(±5%)

Style	Limiting element voltage(V)	Insulation voltage(V)	Number of element	Circuit networks	Category temperature range(°C)
RACA10 4D	50	100	4	D (Independence type)	-55~+155
RACA16 4D					

3.2 Chip Jumper

Table-1(2)

Style	Chip jumper symbol	Resistance value of chip jumper	Rated current of chip jumper(A)
RACA10 4D	JP	50mΩmax.	1
RACA16 4D			1

3.3 Derating

The derated values of dissipation (or current rating in case of chip jumper) at temperature in excess of 70 °C shall be as indicated by the following curve.

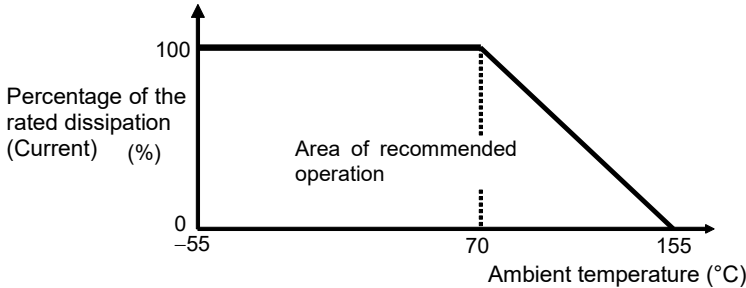


Figure-1Derating curve

3.4 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E : Rated voltage (V)
P : Rated dissipation (W)
R : Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Packaging form		Standard packaging quantity / units	Application
TH	Paper taping	8mm width, 2mm pitches	10,000 pcs.	RACA10 4D
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RACA16 4D

5. Dimensions

The resistor shall be of the design and physical dimensions in accordance with below.

5.1 RACA10 4D

5.1.1 Dimensions

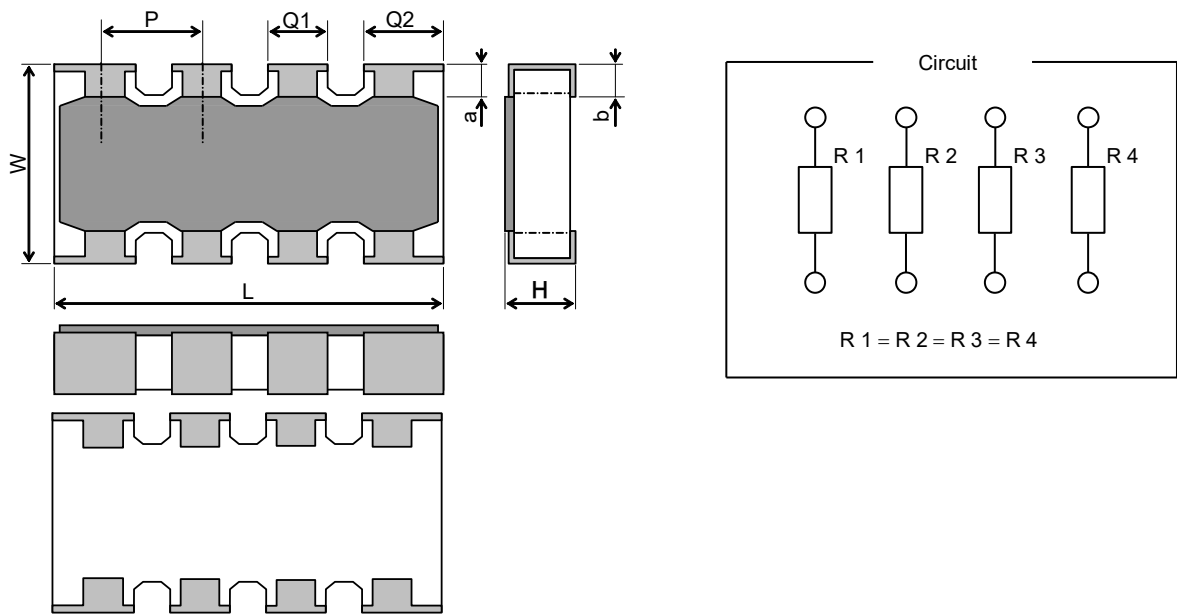


Figure-2

Table-3

Unit: mm

Style	Terminations style	L	W	H	Q ₁	*Q ₂
RACA10 4D	C	2.0±0.1	1.0±0.1	0.35±0.10	0.3±0.1	0.4±0.1

Style	a	b	*P
RACA10 4D	0.2±0.1	0.25±0.15	0.5

*Reference

5.1.2 Net weight (Reference)

Style	Terminations style	Net weight(mg)
RACA10 4D	C	2.2

5.2 RACA16 4D

5.2.1 Dimensions

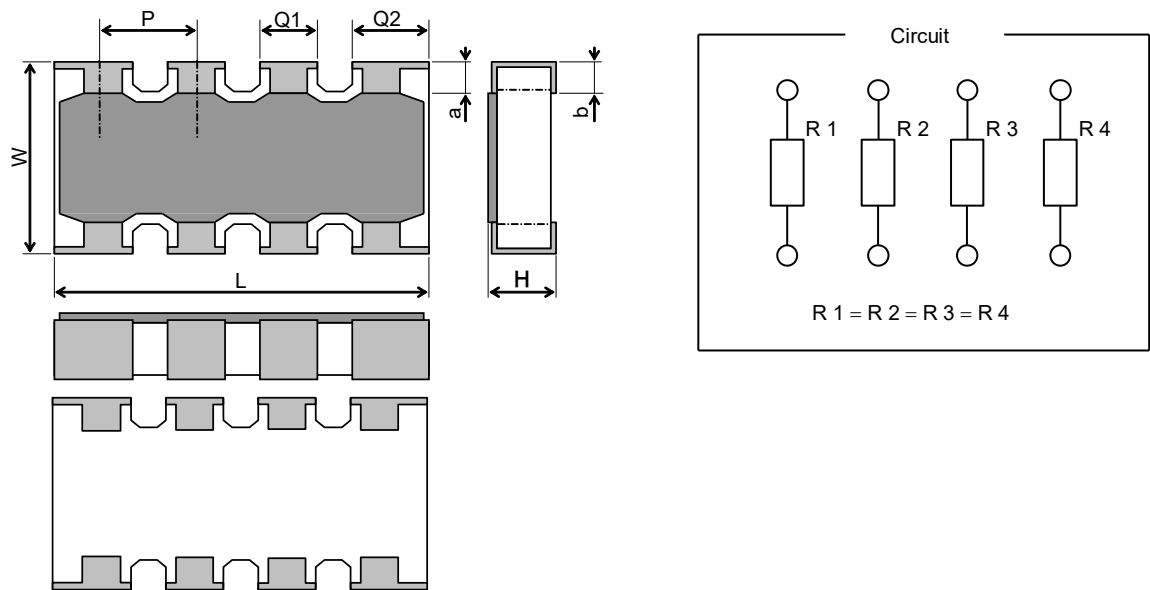


Figure-3

Table-4

Unit: mm

Style	Terminations style	L	W	H	Q ₁	*Q ₂
RACA16 4D	C	3.2±0.15	1.6±0.15	0.5±0.1	0.45±0.15	0.65±0.15

Style	a	b	*P	*Reference
RACA16 4D	0.3±0.15	0.3±0.2	0.8	

5.2.2 Net weight (Reference)

Style	Terminations style	Net weight(mg)
RACA16 4D	C	7

6. Marking

6.1 For the resistors

The rated resistance shall be marked in 3 digits (E24) and marked on over coat side.

- No marking in the E96 series.

Marking example	Contents	Application
1R2	1.2 [Ω]	RACA104D RACA164D
123	12×10 ⁻³ [Ω] → 12 [kΩ]	RACA104D RACA164D

6.2 Marking example of Jumper Chip

Marking example	Contents	Application
000	JP	RACA104D RACA164D

7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4. 2, JIS C 5201-1: 2011.

7.2 The performance shall be satisfied in Table-5.

Table-5(1)

No.	Test items	Condition of test	Performance requirements
1	High temperature exposure AEC Q200 - No.3	MIL-STD-202 Method 108 Ambient temperature: 155±2°C, Condition: Without load, Duration: 1000 ⁺⁴⁸ ₀ h Interval measurements: 250 h and 500 h	Resistor: ΔR/R: Within ±(3%+0.1Ω) Chip jumper: 50mΩ max. No visible damage
2	Temperature cycling AEC Q200 - No.4	JESD22 Method JA-104 Temperature: -55±3°C / 125±2°C, Dwell time: 30min maximum at each temp. Transition time: 1 min. max. Number of cycles: 1000 cycles. Interval measurements: 250 cy and 500 cy	Resistor: ΔR/R: Within ±(3%+0.05Ω) Chip jumper: 50mΩ max. No visible damage
3	Bias humidity AEC Q200 – No.7	MIL-STD-202 Method 103 Condition: 85°C & 85% R.H. Test power: 10% of rated power shall be applied for continuously. Duration: 1,000 ⁺⁴⁸ ₀ h Interval measurements: 250 h and 500 h	Resistor: ΔR/R: Within ±(3%+0.1Ω) Chip jumper: 50mΩ max. No visible damage
4	Operational life AEC Q200 – No.8	MIL-STD-202 Method 108 Ambient temperature: 125±2°C The applied voltage shall be the voltage to be calculated at 35% of rated dissipation or the limiting element voltage whichever is the smaller. Condition: The voltage shall be applied for continuously. Duration: 1000 ⁺⁴⁸ ₀ h Interval measurements: 250 h and 500 h	Resistor: ΔR/R: Within ±(3%+0.1Ω) Chip jumper: 50mΩ max. No visible damage
5	External Visual AEC Q200 – No.9	MIL-STD-883 Method 2009	Inspect device construction, marking and workmanship.
6	Dimensions AEC Q200 – No.10	JESD22 Method JB-100	As in Table-3
7	Resistance to Solvents AEC Q200 – No.12	MIL-STD-202 Method 215 Solvent: 2-propanol at 25°C Immersion time: 3 min Brush: 10 times brushing Immersion and brush cycle: 3cycle	Resistor: ΔR/R: Within ±(1%+0.05Ω) Chip jumper: 50mΩ max. No visible damage
8	Mechanical Shock AEC Q200 – No.13	MIL-STD-202 Method 213 Waveform: half sine, Peak value 100g's, Normal duration 6ms Condition: XX'YY'ZZ', 18times total	Resistor: ΔR/R: Within ±(1%+0.05Ω) Chip jumper: 50mΩ max. No visible damage

Table-5(2)

No	Test items	Condition of test	Performance requirements
9	Vibration AEC Q200 – No.14	MIL-STD-202 Method 204 Peak acceleration and Sweep time: 5 g's for 20 min , Frequency 10Hz to 2000Hz, Condition: 12 cycles each of 3 orientations	Resistor: $\Delta R/R$: Within $\pm(1\%+0.05\Omega)$ Chip jumper: 50m Ω max. No visible damage
10	Resistance to soldering heat AEC Q200 - No.15	MIL-STD-202 Method 210 Solder bath temp: 260 \pm 5 $^{\circ}$ C Immersed time: 10 \pm 1s	Resistor: $\Delta R/R$: Within $\pm(1\%+0.05\Omega)$ Chip jumper: 50m Ω max. No visible damage
11	ESD test AEC Q200 – No.17	AEC-Q200-002 Human body model, 2 Kohm, 150 pF, Test voltage: 500V	Resistor: $\Delta R/R$: Within $\pm(1\%+0.05\Omega)$ No visible damage
12	Solderability AEC Q200 – No.18	J-STD-002 a) Bake the sample for 155 $^{\circ}$ C dwell time 4h / solder dipping 235 $^{\circ}$ C/ 5s. Solder: Sn96.5-Ag3-Cu0.5 b) Category 3, Solder dipping 215 $^{\circ}$ C/ 5s. Solder: Sn63Pb37 c) Category 3, Solder dipping 260 $^{\circ}$ C/ 7s.	The surface of terminal immersed shall be min. of 95% covered with a new coating of solder.
13	Electrical Characterization AEC Q200 - No.19	1. D.C. Resistance 2. Temperature Coefficient of Resistance -55 $^{\circ}$ C / +20 $^{\circ}$ C +20 $^{\circ}$ C / +155 $^{\circ}$ C	1. The resistance value shall correspond with the rated resistance taking into account the specified tolerance. Chip jumper: 50m Ω max. 2. As in Table-1
14	Flammability AEC Q200 – No.20	UL-94	V-0 or V-1 are acceptable
15	Bending strength AEC Q200 – No.21	AEC-Q200-005 Bending value2mm Holding time: 60sec.	Resistor: $\Delta R/R$: Within $\pm(1\%+0.05\Omega)$ Chip jumper: 50m Ω max. No visible damage
16	Adhesion AEC Q200 – No.22	AEC-Q200-006 Pressurizing force: 17.7N Test time: 60 \pm 1s.	Resistor: $\Delta R/R$: Within $\pm(1\%+0.05\Omega)$ Chip jumper: 50m Ω max. No remarkable damage or removal of the terminations
17	Salt Spray AEC Q200 – No.29	MIL-STD-202 Method 101 Test condition B	Resistor: $\Delta R/R$: Within $\pm(1\%+0.05\Omega)$ Chip jumper: 50m Ω max. No visible damage

8. Taping

8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010

8.2 Taping dimensions

8.2.1 RACA10 4D Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-4 and Table-6.

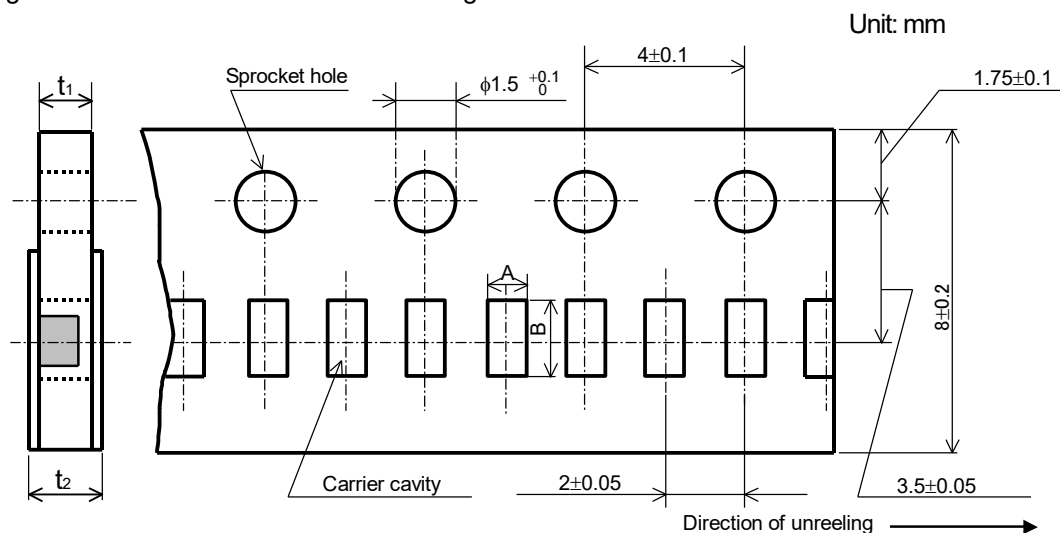


Figure-4

Table-6

Unit: mm

Style	A	B	t_1	t_2
RACA10 4D	1.2 ± 0.1	2.2 ± 0.1	0.4 ± 0.1	0.5max.

8.2.2 RACA16 4D Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-5 and Table-7.

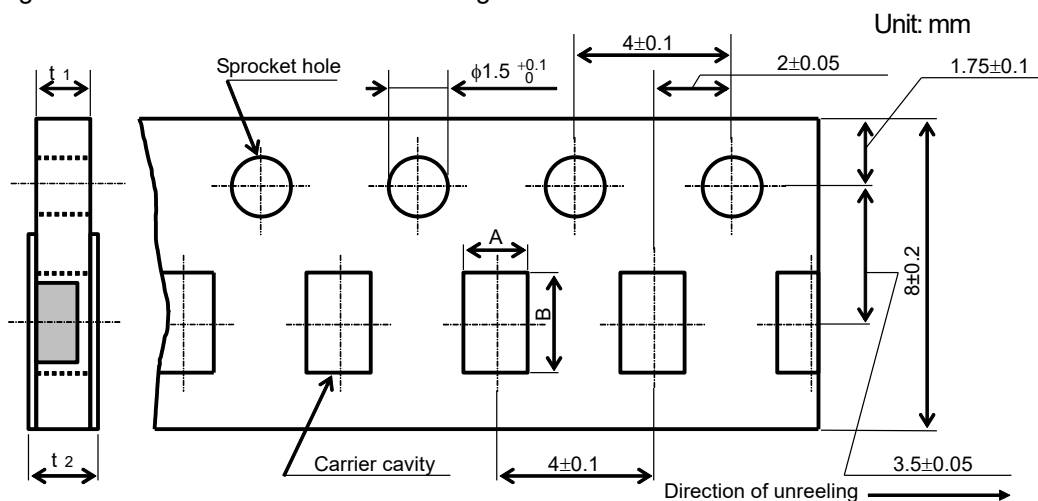


Figure-5

Table-7

Unit: mm

Style	A	B	t_1	t_2
RACA16 4D	1.9 ± 0.15	3.6 ± 0.2	0.6 ± 0.1	0.8max.

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches $\pm 0.2\text{mm}$.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following Figure-6.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.
The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

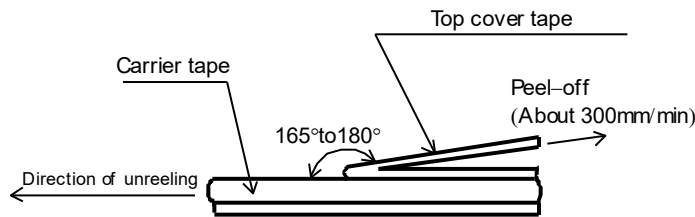


Figure-6

8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-7 and Table-8.

Plastic reel (Based on EIAJ ET-7200C)

Unit: mm

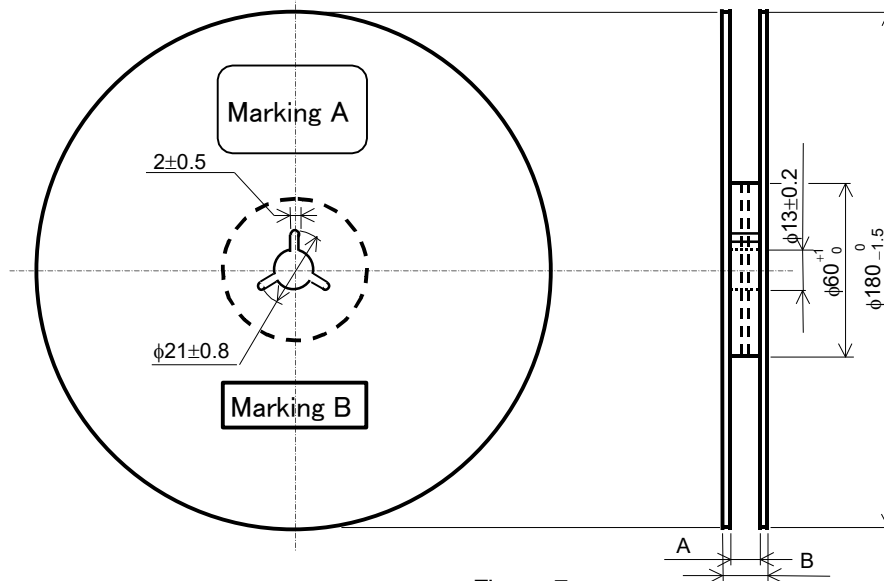


Figure-7

Table-8

Unit: mm

Style	A	B	Note
RACA10,16	9 $^{+1.0}_{0}$	11.4 ± 1.0	Injection molding
		13 ± 1.0	Vacuum forming

Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

8.4 Leader and trailer tape.

(Example)

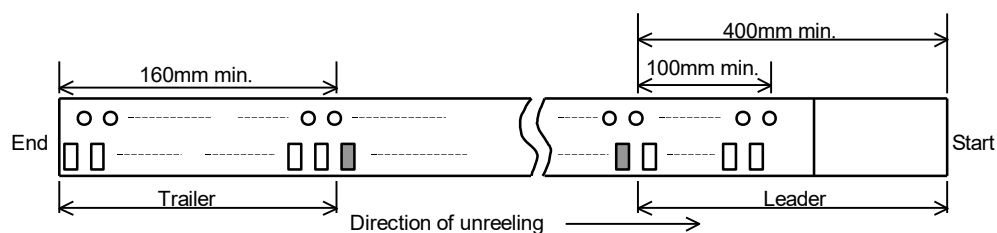


Figure-8

9. Marking on package

The label of a minimum package shall be legibly marked with follows.

9.1 Marking A

(1) Classification (Style, Rated resistance, Tolerance on rated resistance, Terminal style, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

9.2 Marking B (KAMAYA Control label)